

# 74LVT162245B

3.3 V 16-bit transceiver with 30 Ohm termination resistors; 3-state

Rev. 6 — 8 July 2024

**Product data sheet** 

nexperia

### 1. General description

The 74LVT162245B is a 16-bit transceiver with 30  $\Omega$  termination resistors and 3-state outputs. The device can be used as two 8-bit transceivers or one 16-bit transceiver. The device features two output enables (1 $\overline{OE}$  and 2 $\overline{OE}$ ) each controlling eight outputs, and two send/receive (1DIR and 2DIR) inputs for direction control. A HIGH on n $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs

### 2. Features and benefits

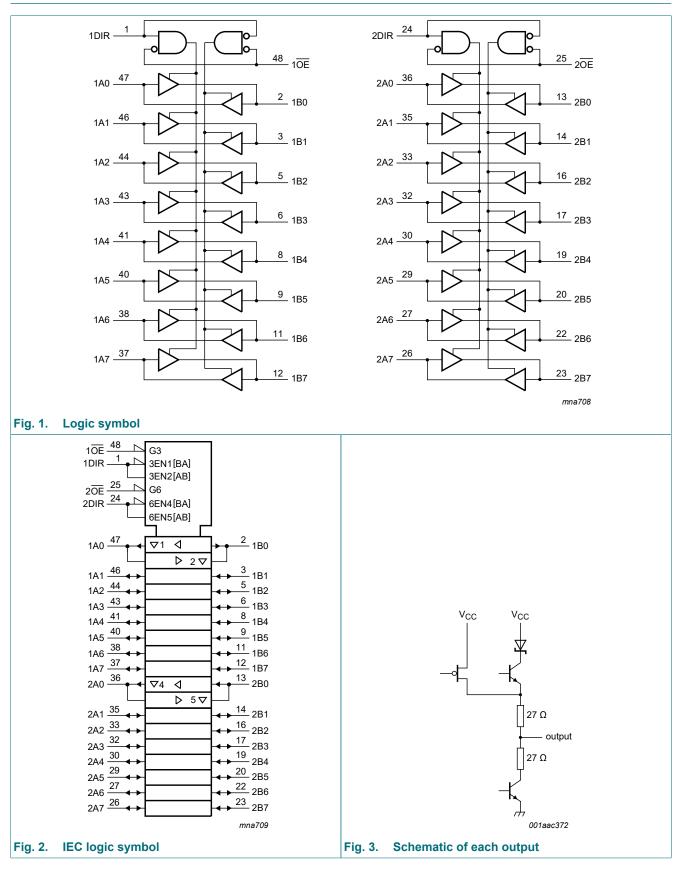
- 16-bit bidirectional bus interface
- 3-state buffers
- Output capability: +12 mA/–12 mA
- Wide supply voltage range from 2.7 V to 3.6 V
- BiCMOS high speed and output drive
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Outputs include series resistance of 30 Ω making external termination resistors unnecessary
- Power-up 3-state
- No bus current loading when output is tied to 5 V bus
- IOFF circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- Complies with JEDEC standards JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to 85 °C

## 3. Ordering information

#### Table 1. Ordering information

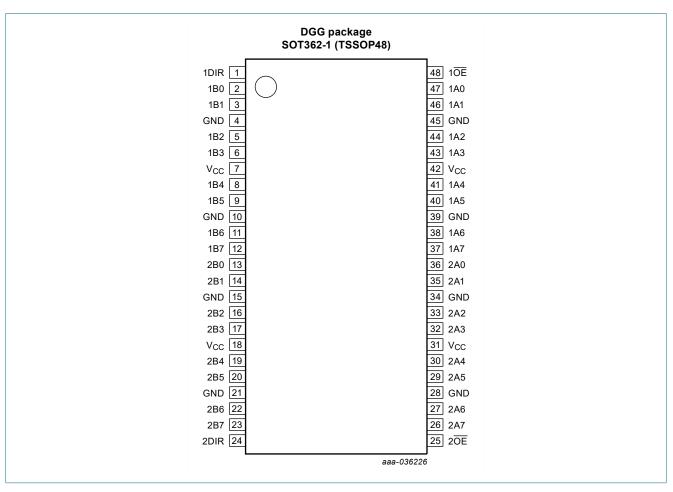
Type number	Package			
	Temperature range	Name	Description	Version
74LVT162245BDGG	-40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	<u>SOT362-1</u>

## 4. Functional diagram



74LVT162245B

### 5. Pinning information



### 5.1. Pinning

### 5.2. Pin description

#### Table 2. Pin description

Symbol	Pin	Description
1DIR, 2DIR	1, 24	direction control input
1A0, 1A1, 1A2, 1A3, 1A4, 1A5, 1A6, 1A7	47, 46, 44, 43, 41, 40, 38, 37	data input/output
2A0, 2A1, 2A2, 2A3, 2A4, 2A5, 2A6, 2A7	36, 35, 33, 32, 30, 29, 27, 26	data input/output
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
1B0, 1B1, 1B2, 1B3, 1B4, 1B5, 1B6, 1B7	2, 3, 5, 6, 8, 9, 11, 12	data input/output
2B0, 2B1, 2B2, 2B3, 2B4, 2B5, 2B6, 2B7	13, 14, 16, 17, 19, 20, 22, 23	data input/output
10E, 20E	48, 25	output enable input
V <sub>cc</sub>	7, 18, 31, 42	supply voltage

### 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Control		Input/output		
nOE	nDIR	nAn	nBn	
L	L	output nAn = nBn	input	
L	Н	input	output nBn = nAn	
Н	Х	Z	Z	

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state [1]	-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
I <sub>O</sub>	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-64	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature	[2]	-	150	°C

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

## 8. Recommended operating conditions

#### Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>CC</sub>	supply voltage		2.7	-	3.6	V
VI	input voltage		0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	outputs enabled	-	-	10	ns/V

### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions;  $T_{amb} = -40$  °C to 85 °C; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Мах	Unit
V <sub>IK</sub>	input clamping voltage	V <sub>CC</sub> = 2.7 V; I <sub>IK</sub> = -18 mA		-	0.8	-1.2	V
VIH	HIGH-level input voltage			2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage			-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -12 mA		2.0	2.5	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 12 mA		-	0.3	0.8	V
I <sub>OH</sub>	HIGH-level output current			-	-	-12	mA
I <sub>OL</sub>	LOW-level output current			-	-	12	mA
l <sub>l</sub>	input leakage current	control pins					
		V <sub>CC</sub> = 0 V or 3.6 V; V <sub>I</sub> = 5.5 V		-	0.1	10	μA
		$V_{CC}$ = 3.6 V; $V_{I}$ = $V_{CC}$ or GND		-	0.1	±1	μA
		I/O data pins; V <sub>CC</sub> = 3.6 V	[2]				
		V <sub>I</sub> = V <sub>CC</sub>		-	0.5	10	μA
		V <sub>I</sub> = 0 V		-	0.1	-5	μA
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 V; V_1 \text{ or } V_0 = 0 V \text{ to } 4.5 V$		-	0.1	±100	μA
I <sub>BHL</sub>	bus hold LOW current	V <sub>CC</sub> = 3 V; V <sub>I</sub> = 0.8 V		75	130	-	μA
I <sub>BHH</sub>	bus hold HIGH current	V <sub>CC</sub> = 3 V; V <sub>I</sub> = 2.0 V		-75	-130	-	μA
I <sub>BHLO</sub>	bus hold LOW overdrive current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = 0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	500	-	-	μA
I <sub>BHHO</sub>	bus hold HIGH overdrive current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = 0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	-500	μA
I <sub>CEX</sub>	output high leakage current	output in HIGH-state when $V_O > V_{CC}$ ; $V_O = 5.5 V$ ; $V_{CC} = 3.0 V$		-	75	125	μA
I <sub>O(pu/pd)</sub>	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ $V_I = \text{GND or } V_{CC}; n\overline{\text{OE}} = \text{don't care}$	[4]	-	40	±100	μA
l <sub>oz</sub>	OFF-state output current	$V_{CC}$ = 3.6 V; $V_{I}$ = $V_{IL}$ or $V_{IH}$					
		output HIGH: V <sub>O</sub> = 3.0 V		-	0.5	5	μA
		output LOW: V <sub>O</sub> = 0.5 V		-	0.5	-5	μA
I <sub>CC</sub>	supply current	$V_{CC}$ = 3.6 V; $V_{I}$ = GND or $V_{CC}$ ; $I_{O}$ = 0 A					
		outputs HIGH		-	0.07	0.12	mA
		outputs LOW		-	4.2	6	mA
		outputs disabled	[5]	-	0.07	0.12	mA
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_{CC}$ = 3 V to 3.6 V; one input at $V_{CC}$ - 0.6 V and other inputs at $V_{CC}$ or GND	[6]	-	0.1	0.2	mA
CI	input capacitance	nDIR and n <del>OE</del> ; V <sub>I</sub> = 0 V or 3.0 V		-	3	-	pF
C <sub>I/O</sub>	input/output capacitance	V <sub>I/O</sub> = 0 V or 3.0 V		-	9	-	pF

[1] Typical values are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

[2] Unused pins at V<sub>CC</sub> or GND.

[3] This is the bus hold overdrive current required to force the input to the opposite logic state.

[4] This parameter is valid for any  $V_{CC}$  between 0 V and 1.2 V with a transition time of up to 10 ms.

From  $V_{CC}$  = 1.2 V to  $V_{CC}$  = 3.3 V ± 0.3 V a transition time of 100 µs is permitted. This parameter is valid for  $T_{amb}$  = 25 °C only.

[5] Measured with outputs pulled to  $V_{CC}$  or GND.

[6] This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND.

## **10.** Dynamic characteristics

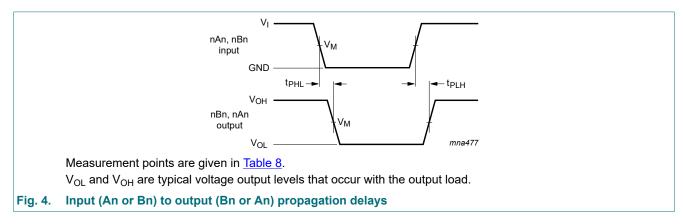
#### Table 7. Dynamic characteristics

At recommended operating conditions;  $T_{amb} = -40$  °C to 85 °C; voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 6.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
t <sub>PLH</sub>	LOW to HIGH	nAn to nBn or nBn to nAn; see Fig. 4				
	propagation delay	V <sub>CC</sub> = 2.7 V	-	-	3.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.5	3.5	ns
t <sub>PHL</sub>	HIGH to LOW	nAn to nBn or nBn to nAn; see <u>Fig. 4</u>				
	propagation delay	V <sub>CC</sub> = 2.7 V	-	-	3.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.2	3.5	ns
t <sub>PZH</sub>	OFF-state to HIGH	nOE to nAn or nBn; see Fig. 5				
	propagation delay	V <sub>CC</sub> = 2.7 V	-	-	6.4	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	3.5	5.3	ns
t <sub>PZL</sub>	L OFF-state to LOW	nOE to nAn or nBn; see Fig. 5				
	propagation delay	V <sub>CC</sub> = 2.7 V	-	-	5.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	3.2	4.4	ns
t <sub>PHZ</sub>	HIGH to OFF-state	nOE to nAn or nBn; see <u>Fig. 5</u>				
	propagation delay	V <sub>CC</sub> = 2.7 V	-	-	5.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	3.5	4.8	ns
t <sub>PLZ</sub>	LOW to OFF-state	nOE to nAn or nBn; see Fig. 5				
	propagation delay	V <sub>CC</sub> = 2.7 V	-	-	5.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	4.3	6.7	ns

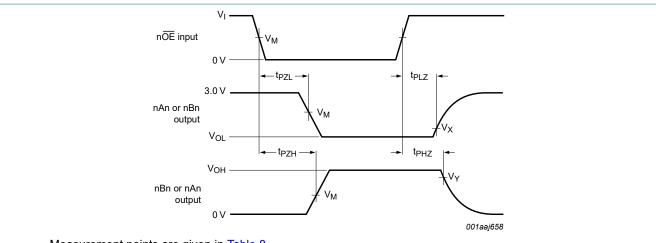
[1] Typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

### 10.1. Waveforms and test circuit



### 74LVT162245B

#### 3.3 V 16-bit transceiver with 30 Ohm termination resistors; 3-state



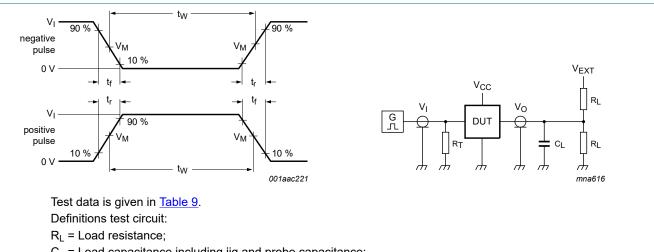
Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

#### Fig. 5. 3-state output enable and disable times

### Table 8. Measurement points

Input		Output			
VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	
2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V	



C<sub>L</sub> = Load capacitance including jig and probe capacitance;

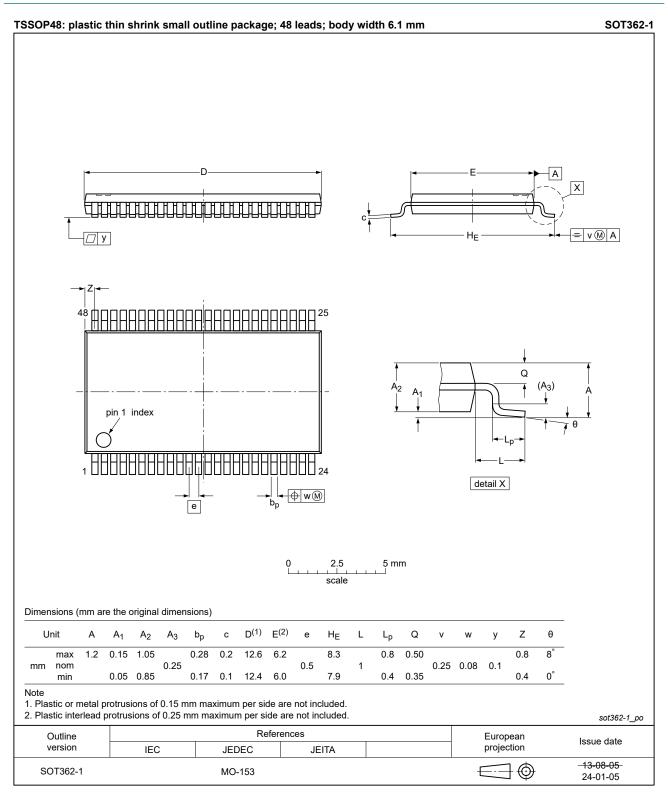
 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator;

V<sub>EXT</sub> = Test voltage for switching times.

#### Fig. 6. Test circuit for measuring switching times

Table 9. Test data								
Input			Load		V <sub>EXT</sub>			
VI	fi	t <sub>W</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHZ</sub> , t <sub>PZH</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>
2.7 V	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V	open

### **11. Package outline**



#### Fig. 7. Package outline SOT362-1 (TSSOP48)

### 12. Abbreviations

Table 10. Abbrevia	Table 10. Abbreviations				
Acronym	Description				
ANSI	American National Standards Institute				
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor				
CDM	Charged Device Model				
DUT	Device Under Test				
ESD	ElectroStatic Discharge				
ESDA	ElectroStatic Discharge Association				
HBM	Human Body Model				
JEDEC	Joint Electron Device Engineering Council				
TTL	Transistor-Transistor Logic				

# 13. Revision history

Table 11. Revision hist	ory						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVT162245B v.6	20240708	Product data sheet	-	74LVT162245B v.5			
Modifications:	• <u>Section 2</u> : ES	<u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.					
74LVT162245B v.5	20240320	Product data sheet	-	74LVT162245B v.4			
Modifications:	• Fig. 7: Updat	• Fig. 7: Updated package outline drawing SOT362-1 (TSSOP48).					
74LVT162245B v.4	20210806	Product data sheet	-	74LVT162245B v.3			
Modifications:	•••	74LVT162245BDL (SOT370 d <u>Section 2</u> updated.	-1/SSOP48) removed	l.			
74LVT162245B v.3	20181001	Product data sheet	-	74LVT162245B v.2			
Modifications:	Nexperia.	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
74LVT162245B v.2	19980219	Product specification	-	74LVT162245B v.1			
74LVT162245B v.1	19950822	Product specification	-	-			

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#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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